

● General Description

The AGM1099EY combines advanced trench MOSFET technology with a low resistance package to provide extremely low $R_{DS(ON)}$.

This device is ideal for load switch and battery protection applications.

● Features

- Advance high cell density Trench technology
- Low $R_{DS(ON)}$ to minimize conductive loss
- Low Gate Charge for fast switching
- Low Thermal resistance
- 100% Avalanche tested
- 100% DVDS tested

● Application

- MB/VGA Vcore
- SMPS 2nd Synchronous Rectifier
- POL application
- BLDC Motor driver

Product Summary

BVDSS	RDSON	ID
100V	92mΩ	5.0A

SOT-89 Pin Configuration

Package Marking and Ordering Information

Device Marking	Device	Device Package	Reel Size	Tape width	Quantity
AGM1099EY	AGM1099EY	SOT-89	330mm	12mm	3000

Table 1. Absolute Maximum Ratings (TA=25°C)

Symbol	Parameter	Value	Unit
VDS	Drain-Source Voltage (VGS=0V)	100	V
VGS	Gate-Source Voltage (VDS=0V)	±20	V
ID	Drain Current-Continuous(TA=25°C) (Note 1)	5.0	A
	Drain Current-Continuous(TA=100°C)	3.2	A
IDM (pluse)	Drain Current-Pulsed (Note 2)	20	A
PD	Maximum Power Dissipation(TA=25°C)	3.1	w
EAS	Avalanche energy (Note 3)	3.2	mJ
TJ,TSTG	Operating Junction and Storage Temperature Range	-55 To 150	°C

Table 2. Thermal Characteristic

Symbol	Parameter	Typ	Max	Unit
RθJA	Thermal Resistance Junction-ambient (Steady State) ¹	---	40	°C/W

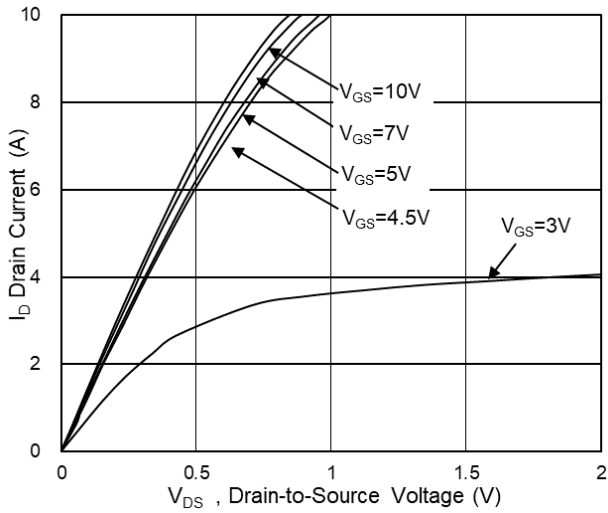
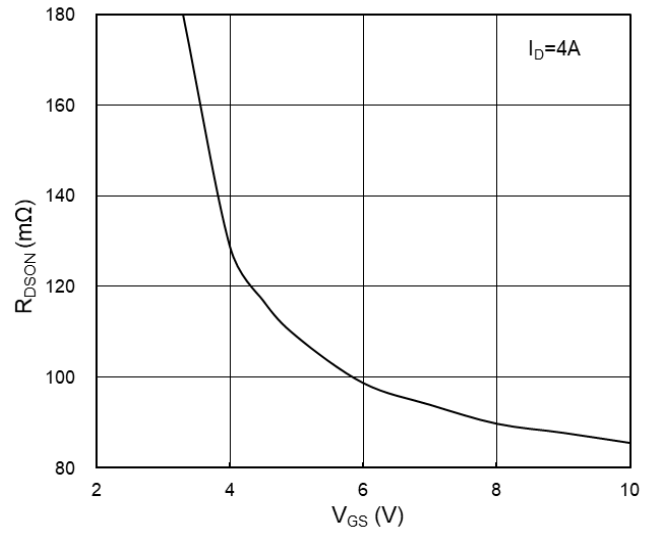
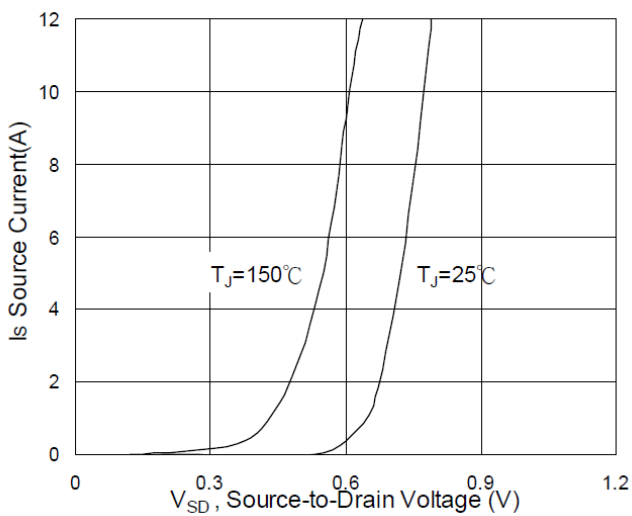
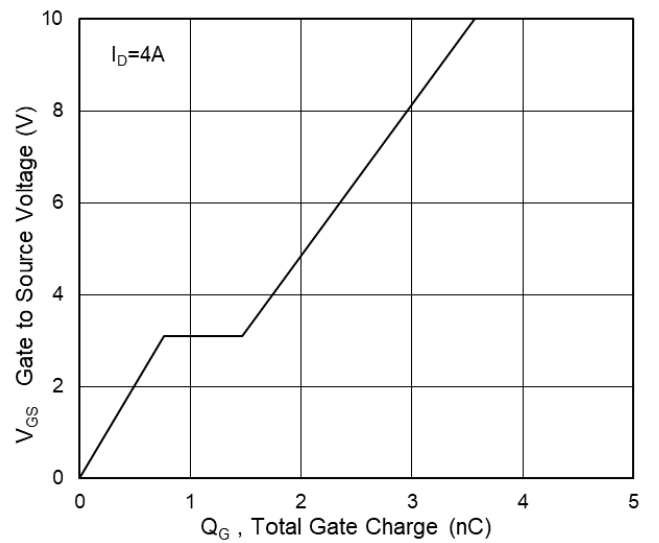
Table 3. Electrical Characteristics (T_J=25°C unless otherwise noted)

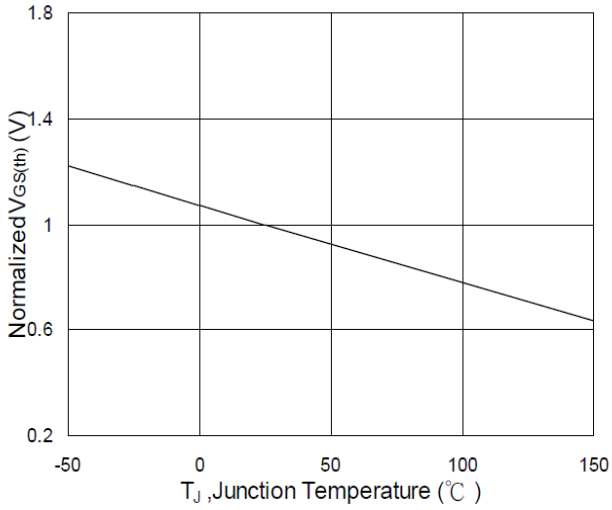
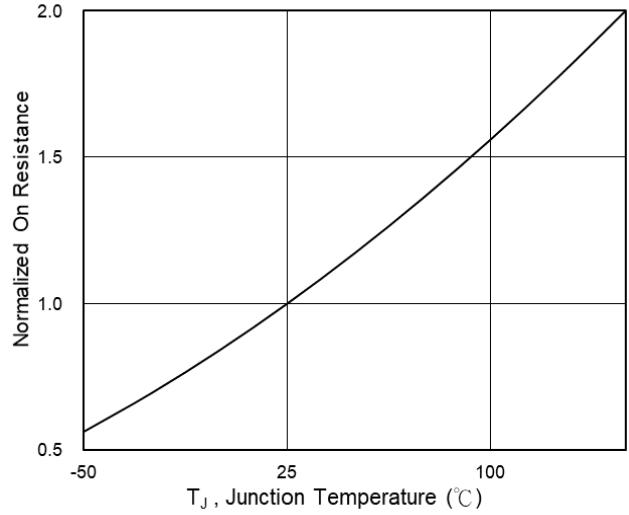
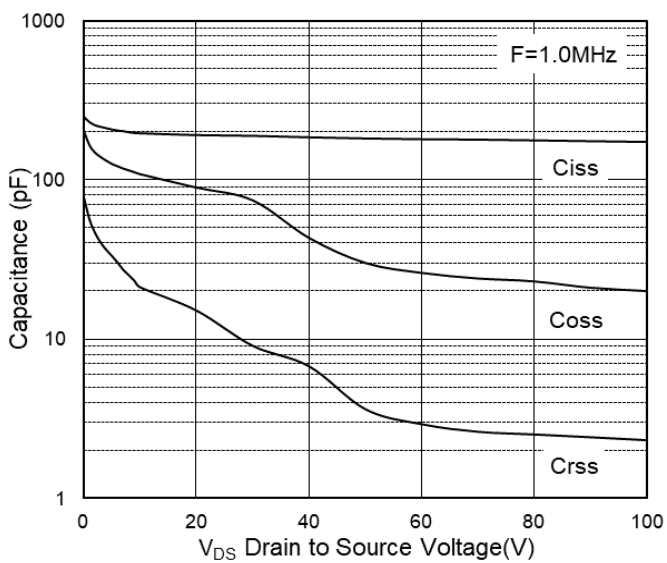
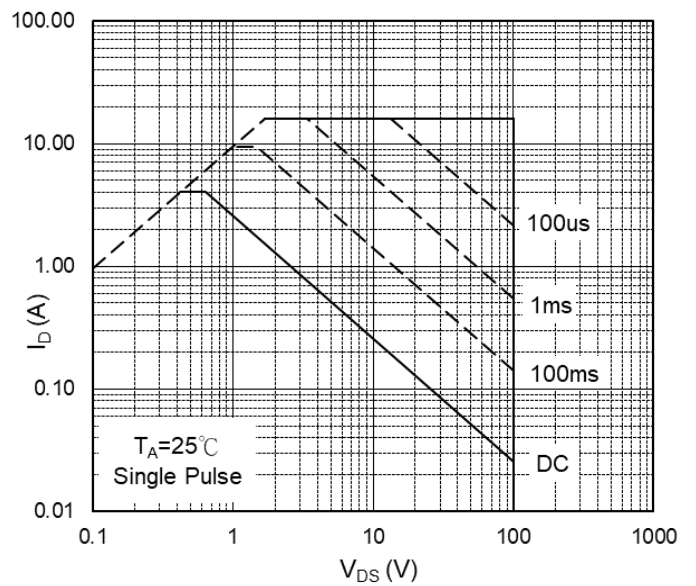
Symbol	Parameter	Conditions	Min	Typ	Max	Unit
On/Off States						
BVDSS	Drain-Source Breakdown Voltage	VGS=0V ID=250μA	100	--	--	V
IDSS	Zero Gate Voltage Drain Current	VDS=100V,VGS=0V	--	--	1	μA
IGSS	Gate-Body Leakage Current	VGS=±20V,VDS=0V	--	--	±100	nA
VGS(th)	Gate Threshold Voltage	VDS=VGS,ID=250μA	1.2	1.7	2.2	V
gFS	Forward Transconductance	VDS=5V,ID=3A	--	2	--	S
RDS(on)	Drain-Source On-State Resistance	VGS=10V, ID=4A	--	92	115	mΩ
		VGS=4.5V, ID=3A	--	108	125	mΩ
Dynamic Characteristics						
Ciss	Input Capacitance	VDS=50V,VGS=0V, F=1MHZ	--	182	--	pF
Coss	Output Capacitance		--	30	--	pF
Crss	Reverse Transfer Capacitance		--	3.6	--	pF
Rg	Gate resistance	VGS=0V, VDS=0V,f=1.0MHz	--	2.5	--	Ω
Switching Times						
td(on)	Turn-on Delay Time	VGS=10V,VDS=50V, ID=5A,RGEN=5Ω	--	11	--	nS
tr	Turn-on Rise Time		--	6.0	--	nS
td(off)	Turn-Off Delay Time		--	30	--	nS
tf	Turn-Off Fall Time		--	4.0	--	nS
Qg	Total Gate Charge	VGS=10V, VDS=50V, ID=5A	--	3.57	--	nC
Qgs	Gate-Source Charge		--	0.76	--	nC
Qgd	Gate-Drain Charge		--	0.71	--	nC
Source-Drain Diode Characteristics						
ISD	Source-Drain Current(Body Diode)		--	--	5.0	A
VSD	Forward on Voltage	VGS=0V,IS=4A	--	--	1.2	V
trr	Reverse Recovery Time	IF=4A , dI/dt=100A/μs ,TJ=25°C	--	50	--	ns
Qrr	Reverse Recovery Charge		--	102	--	nc

Notes 1.The maximum current rating is package limited.

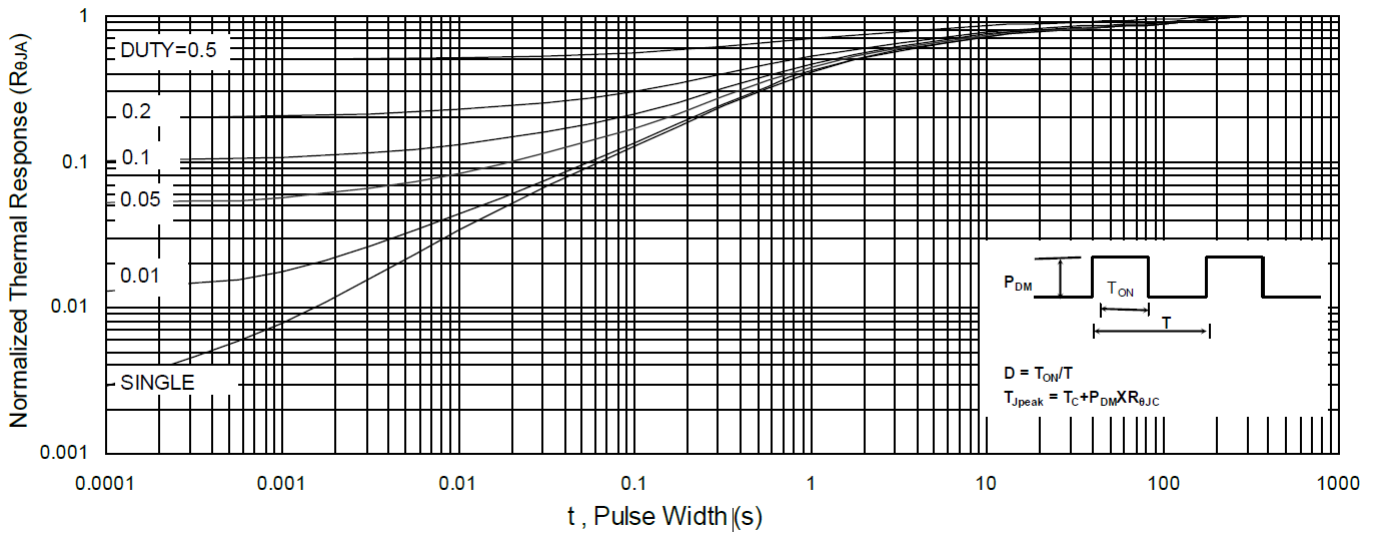
Notes 2.Repetitive Rating: Pulse width limited by maximum junction temperature

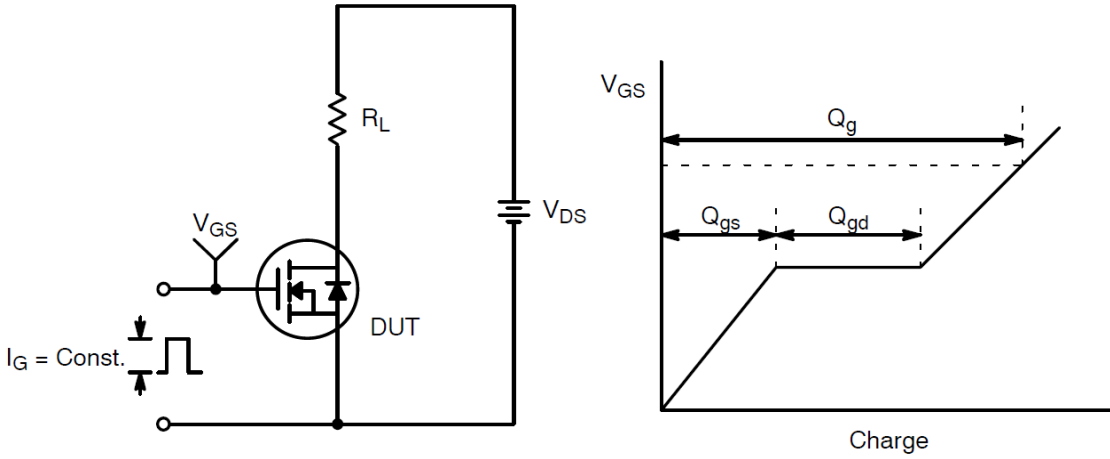
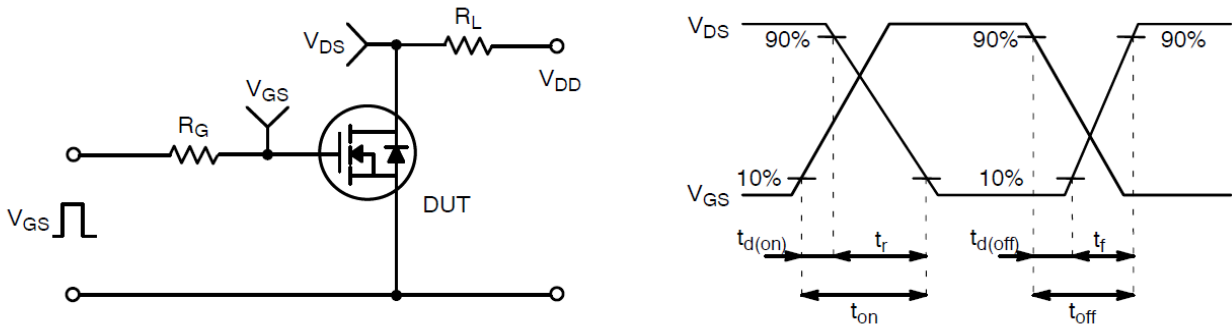
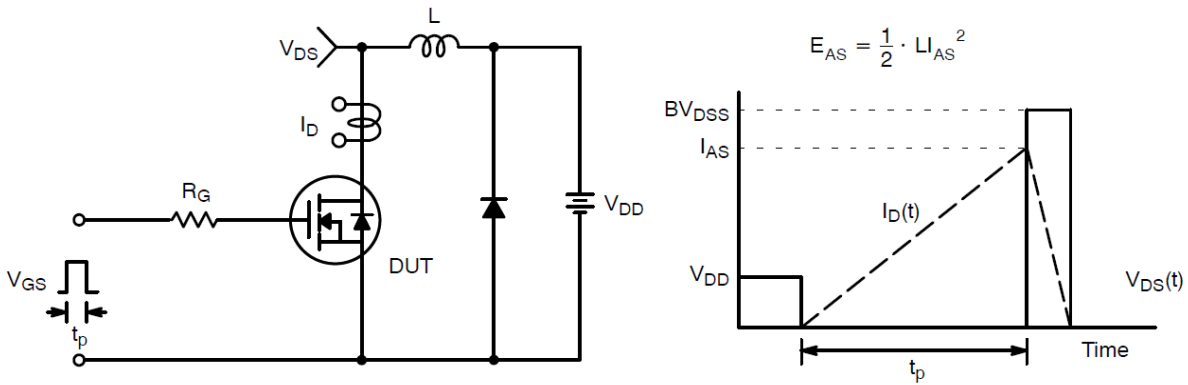
Notes 3.EAS condition: T_J=25°C , VDD=50V,Vgs=10V , ID=3.6A,L=0.5mH,RG=25ohm

Characteristics Curve:
Typ. Output Characteristics

On-Resistance vs G-S Voltage

Source Drain Forward Characteristics

Gate-Charge Characteristics


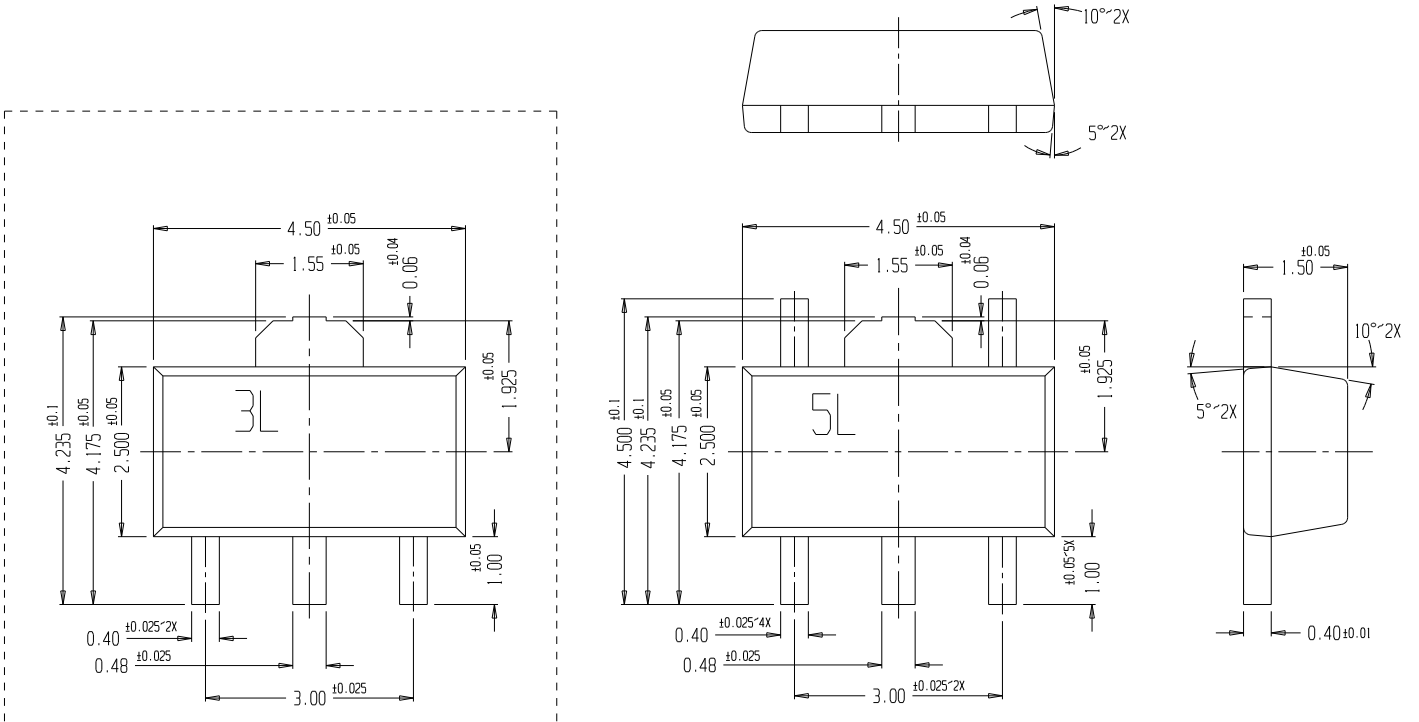
Normalized $V_{GS(th)}$ vs T_J

Normalized $R_{DS(on)}$ vs T_J

Capacitance

Safe Operating Area


Max. transient thermal impedance



Test Circuit and Waveform:

Gate Charge Test Circuit & Waveform

Resistive Switching Test Circuit & Waveforms

Unclamped Inductive Switching Test Circuit & Waveforms

SOT-89 package outline dimensions




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